



HOSTAFORM® LW15EWX

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Hostaform® LW15EWX is a specialty low wear grade of acetal copolymer designed for improved performance including when paired against other thermoplastic resins (PBT, PA, PC, PMMA) or steel. Due to the special wax blend the material has a good weld line strength. Compared to Hostaform® LW90EWX, this grade has higher toughness and strength.

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Product information			
Resin Identification	POM		ISO 1043
Part Marking Code	>POM<		ISO 11469
Rheological properties			
Melt volume-flow rate	2.5	cm ³ /10min	ISO 1133
Temperature	190	°C	
Load	2.16	kg	
Typical mechanical properties			
Tensile modulus	2650	MPa	ISO 527-1/-2
Tensile stress at yield, 50mm/min	63	MPa	ISO 527-1/-2
Tensile strain at yield, 50mm/min	19	%	ISO 527-1/-2
Nominal strain at break	32	%	ISO 527-1/-2
Charpy notched impact strength, 23°C		kJ/m²	ISO 179/1eA
Charpy notched impact strength, -30°C		kJ/m²	ISO 179/1eA
Poisson's ratio	0.38 ^[C]		
[C]: Calculated			
Thermal properties			
Melting temperature, 10 °C/min	173	°C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	93	°C	ISO 75-1/-2
Physical/Other properties			
Density	1400	kg/m³	ISO 1183
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Injection

Drying Recommended	no
Drying Temperature	100 °C
Drying Time, Dehumidified Dryer	3-4 h
Processing Moisture Content	≤0.2 %
Melt Temperature Optimum	200 °C
Min. melt temperature	190 °C
Max. melt temperature	210 °C
Screw tangential speed	≤0.3 m/s
Mold Temperature Optimum	105 °C
Min. mould temperature	90 °C
Max. mould temperature	120 °C
Hold pressure range	60 - 120 MPa
Back pressure	4 MPa

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Revised: 2024-07-17 Source: Celanese Materials Database





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Characteristics

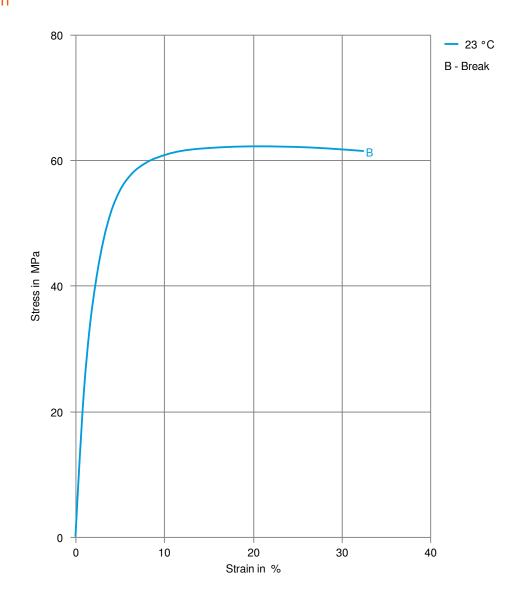
Processing Injection Moulding

Delivery form Pellets

Additives Release agent

Special characteristics Low wear / Low friction

Stress-strain



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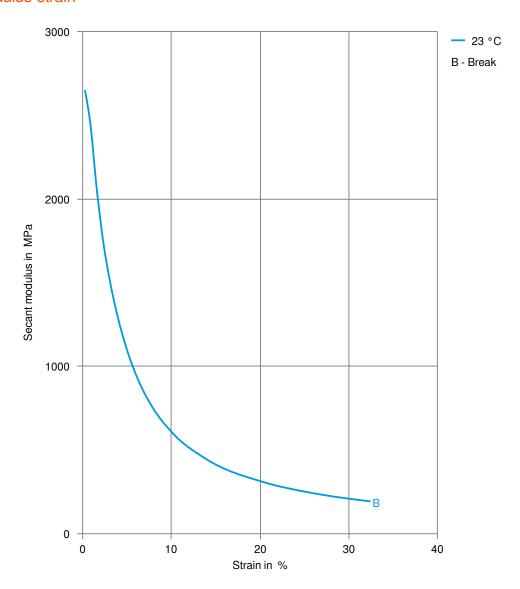
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Secant modulus-strain



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